POWERTIP TECH. CORP.

SPECIFICATIONS

CUSTOMER	:	PTC
SAMPLE CODE	:	SH320240T023-IBA09
MASS PRODUCTION CODE	:	PH320240T023-IBA09
SAMPLE VERSION	:	01
SPECIFICATIONS EDITION	:	002
DRAWING NO. (Ver.)	:	JLMD-PH320240T023-IBA09_001
PACKAGING NO. (Ver.)	:	JPKG-PH320240T023-IBA09_001

Customer Approved

Date:

Approved	Checked	Designer
閆偉	劉進	楊威

☐ Preliminary specification for design input

■ Specification for sample approval

POWERTIP TECH. CORP.

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History of Version

Date	Ver.	Edi.	Description	Page	Design by
03/19/2018	01	001	New Drawing.	-	楊威
05/28/2018	01	002	New Sample	-	楊威

Total: 26 Page

Contents

Note : For detailed information please refer to IC data sheet :
Primacy(TFT LCD): Himax: HX8238-D

1. SPECIFICATIONS

1.1 Features

Main LCD Panel

Item	Standard Value
Display Type	320* (R、G、B) * 240 Dots
LCD Type	a – Si TFT，Normally white , Transmissive type
Screen size(inch)	3.5(Diagonal)
Viewing Direction	6 O'clock
Color configuration	R.G.B. vertical stripe
Backlight	White LED
Interface	Digital 24-bits Parallel RGB HSYNC,VSYNC.3Wires SPI
Other (controller / driver IC)	Himax: HX8238-D
ROHS	THIS PRODUCT CONFORMS THE ROHS OF PTC Detail information please refer website : http://www.powertip.com.tw/news_detail.php?Key=1&cID=1

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	76.9(W) * 63.9 (L) * 3.2 (H)	mm

LCD panel

Item	Standard Value	Unit
Active Area	70.08 (W) * 52.56 (L)	mm

Note : For detailed information please refer to LCM drawing

1.3 Absolute Maximum Ratings

Module

Item	Symbol	Condition	Min.	Max.	Unit
System Power Supply Voltage	VDD	GND=0	-0.3	4.0	V
Booster Reference Supply Voltage	VCI	GND=0	GND-0.3	3.96	V
Operating Temperature	T_{OP}	-	-20	70	°C
Storage Temperature	T_{ST}	-	-30	80	°C
Storage Humidity	HD	Ta < 60 °C	20	90	%RH

1.4 DC Electrical Characteristics

Module GND = 0V, Ta = 25°C

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Power Supply Voltage	VDD	-	3.0	3.3	3.6	V
Booster Reference Supply Voltage	VCI	-	3.0	3.3	3.6	V
V_{COM} High Voltage	V_{COMH}	-	-	-	5.54	V
V_{COM} Low Voltage	V_{COML}	-	-2.8	-	-	V
Input H/L Level Voltage	VIH	-	0.8VDD	-	VDD	V
	VIL	-	0	-	0.2VDD	V
Output H/L Level Voltage	VOH	-	0.9VDD	-	VDD	V
	VOL	-	-	-	0.1VDD	V
Supply Current	IDD	VDD=VCI=3.3V Pattern= black*1	-	7.5	12	mA

Note1: Maximum current display.

1.5 Optical Characteristics

TFT LCD Panel VDD=VCI=3.3V, Ta=25°C

Item		Symbol	Condition	Min.	Typ.	Max.	unit	-
Response time		Tr + Tf	-	-	40	60	ms	Note2
Viewing angle	Top	θY+	CR ≥ 10	-	60	-	Deg.	Note4
	Bottom	θY-		-	60	-		
	Left	θX-		-	60	-		
	Right	θX+		-	60	-		
Contrast ratio		CR	-	500	600	-	-	Note3
Color of CIE Coordinate (With B/L)	White	X	IF= 20 mA	0.26	0.31	0.36	-	Note1
		Y		0.27	0.32	0.37		
	Red	X		0.56	0.61	0.66		
		Y		0.32	0.37	0.42		
	Green	X		0.29	0.34	0.39		
		Y		0.56	0.61	0.66		
	Blue	X		0.09	0.14	0.19		
		Y		0.02	0.07	0.12		
Average Brightness Pattern=white display		IV	IF= 20 mA	380	500	-	cd/m^2	Note1
Uniformity		△B		80	-	-	%	Note1

Note1:

1：△B=B(min) / B(max) × 100%

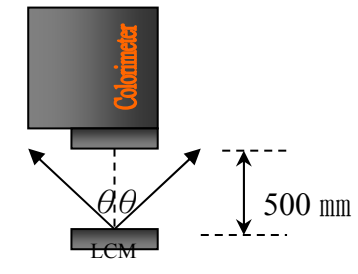
2：Measurement Condition for Optical Characteristics:

a：Environment: 25℃±5℃ / 60±20%R.H，no wind，dark room below 10 Lux at typical lamp current and typical operating frequency.

b：Measurement Distance: 500 ± 50 ㎜ ，(θ= 0°)

c：Equipment: TOPCON BM-7 fast，(field 1°)，after 10 minutes operation.

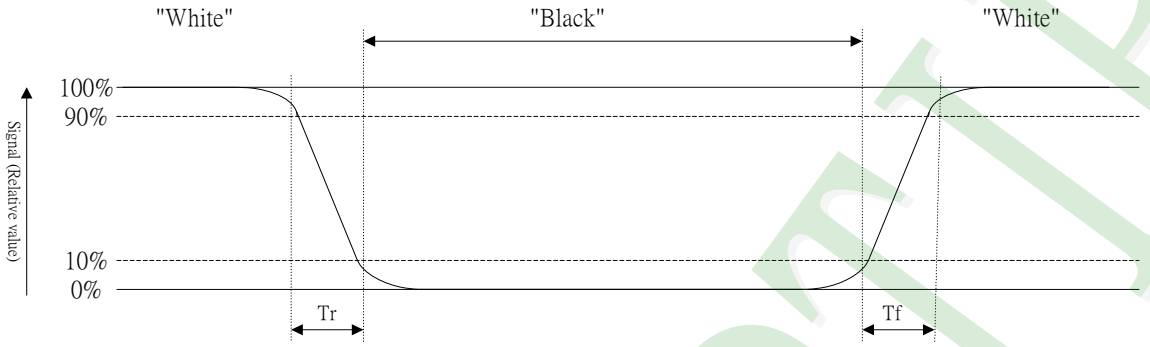
d：The uncertainty of the C.I.E coordinate measurement ±0.01，Average Brightness ± 4%



Colorimeter=BM-7 fast

Note2: Definition of response time:

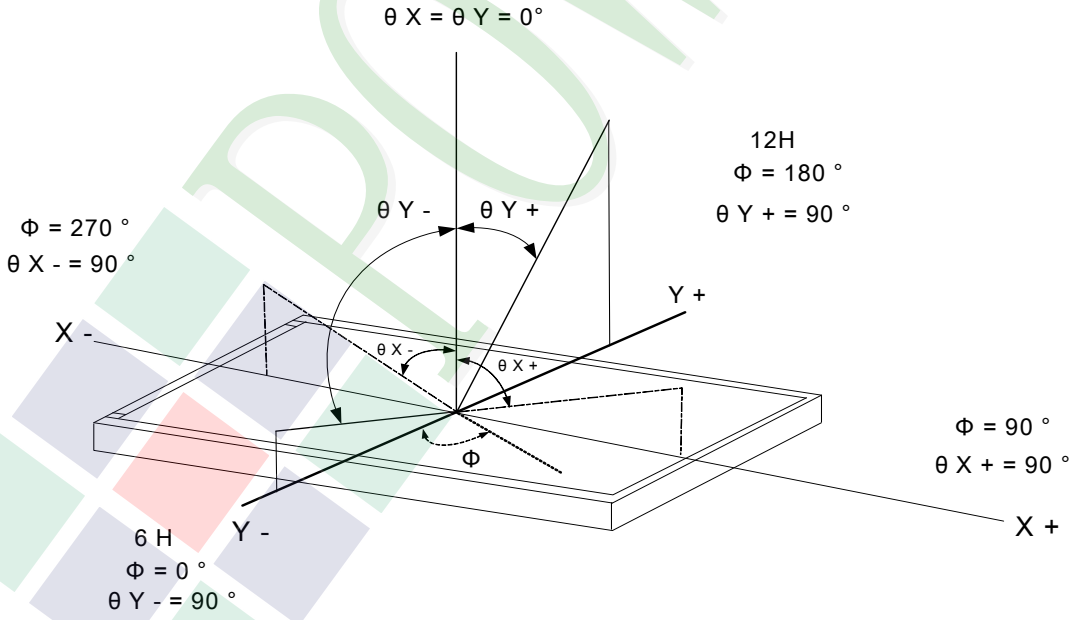
The output signals of photo detector are measured when the input signals are changed from “black” to “white”(falling time) and from “white” to “black”(rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.
Refer to figure as below:



Note3: Definition of contrast ratio:
Contrast ratio is calculated with the following formula

$$\text{Contrast ratio (CR)} = \frac{\text{Photo detector output when LCD is at “White” state}}{\text{Photo detector output when LCD is at “Black” state}}$$

Note4: Definition of viewing angle:
Refer to figure as below:



1.6 Backlight Characteristics

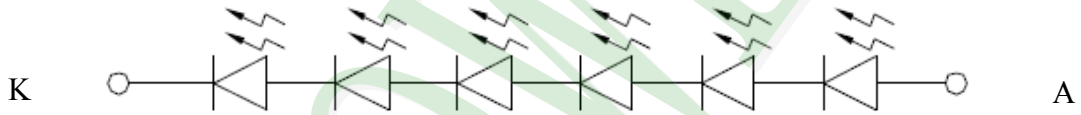
Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
Forward Current	IF	Ta =25℃	-	35	mA
Power Dissipation	PD	Ta =25℃	-	112	mW

Electrical / Optical Characteristics

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward Voltage	VF	IF= 20 mA	-	19.8	21	V
Color of CIE Coordinate (Without LCD & TP)	X		0.26	0.29	0.32	-
	Y		0.26	0.29	0.32	
Color	White					

Internal Circuit Diagram



Other Description

Item	Conditions	Description
Life Time	Ta =25℃ IF= 20mA	20000 hrs

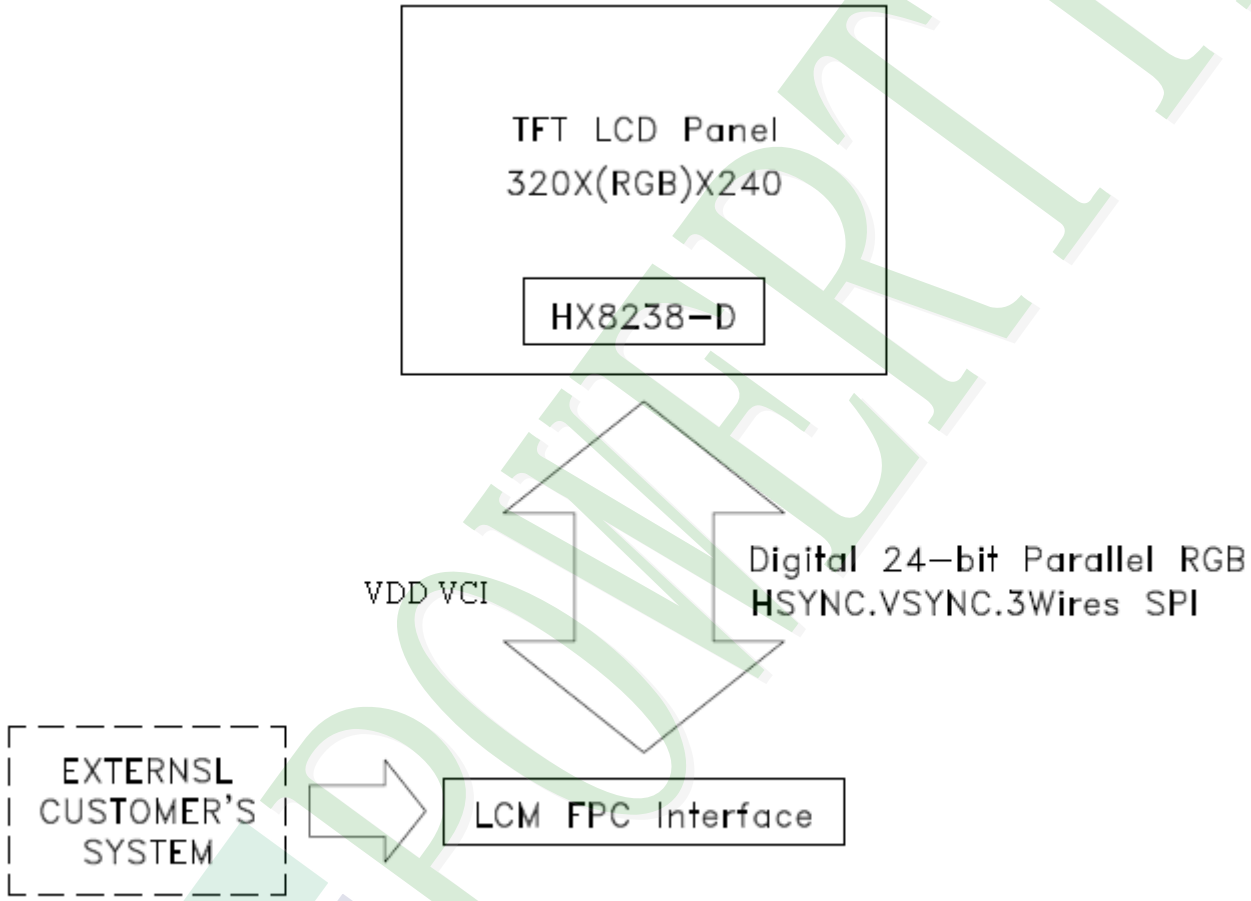
2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram



2.2 Interface Pin Description

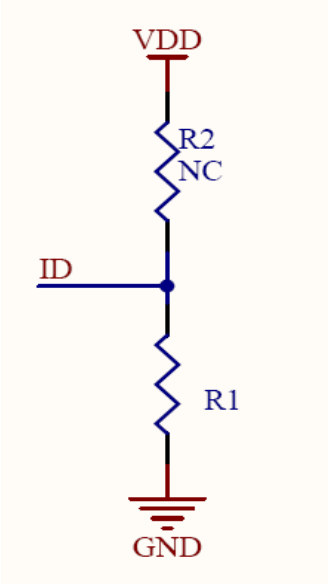
Pin No.	Symbol	Function
1	A	LED Anode.
2	K	LED Cathode.
3	GND	Ground.
4	VCI	Booster Reference Supply Voltage.
5	ID	Note1.
6	VDD	Power Supply Voltage.
7	GND	Ground.
8	RESB	Reset.
9	CSB	Chip select Input: CSB = L - selected and accessible. CSB = H - is not selected and not accessible.
10	SCK	SPI Clock Input.
11	SDO	SPI Data Output. The data is valid on the falling edge of the SCK signal.
12	SDI	SPI Data Input. The data is latched on the rising edge of the SCK signal.
13	GND	Ground.
14	B0	Graphic display Blue data.
15	B1	
16	B2	
17	B3	
18	B4	
19	B5	
20	B6	

Pin No.	Symbol	Function
21	B7	Graphic display Blue data.
22	G0	Graphic display Green data.
23	G1	
24	G2	
25	G3	
26	G4	
27	G5	
28	G6	
29	G7	
30	R0	Graphic display Red data.
31	R1	
32	R2	
33	R3	
34	R4	
35	R5	
36	R6	
37	R7	
38	GND	Ground.
39	DCLK	Video Clock Input. The data is latched on the rising edge of DCLK.
40	HSYNC	Horizontal Sync Input.
41	VSYNC	Vertical Sync Input.

Pin No.	Symbol	Function
42	DEN	Video Data Enable Input. VSYNC+HSYNC mode - This pin is shorted to GND normally and the back/front porch is determined by the control register. VSYNC+HSYNC+DE mode - The valid data is determined by the VSYNC+HSYNC+DEN pin. DE mode - VSYNC and HSYNC are unused and shorted to GND. The valid input. data is determined by DEN pin.
43	GND	Ground.
44	SEL0	Note2.
45	SEL1	
46	SEL2	
47	Y+	Touch Panel Y_Top. (NC)
48	X+	Touch Panel X_Right.(NC)
49	Y-	Touch Panel Y_Bottom. (NC)
50	X-	Touch Panel X_Left. (NC)

Note1: ID code Circuit

Vendor ID (On FPC, ID resistor as specified in vendor table shall be connected to this pin, and other side of the resistor shall be connected to GND)



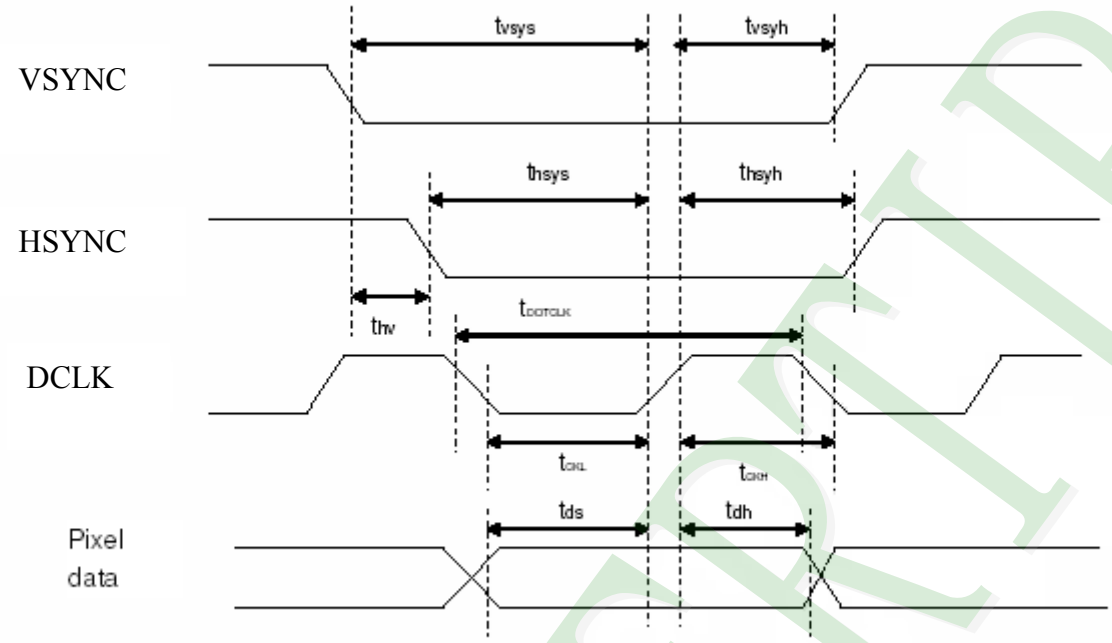
R1=44.2KΩ

Note2: Define the input interface mode

SEL2	SEL1	SEL0	Format	Operating frequency
0	0	0	Parallel-RGB data format (only support stripe type color filter)	6.5MHz
0	0	1	Serial-RGB data format	19.5MHz
0	1	0	CCIR 656 data format (640RGB)	24.54MHz
0	1	1	CCIR 656 data format (720RGB)	27MHz
1	0	0	YUV mode A data format (Cr-Y-Cb-Y)	24.54MHz
1	0	1	YUV mode A data format (Cr-Y-Cb-Y)	27MHz
1	1	0	YUV mode B data format (Cb-Y-Cr-Y)	27MHz
1	1	1	YUV mode B data format (Cb-Y-Cr-Y)	24.54MHz

Input format	DOTCLK Freq (MHz)	Display data	Active area (DOTCLK)
YUV mode	24.54	640	1280
	27	720	1440

2.3 Timing Characteristics

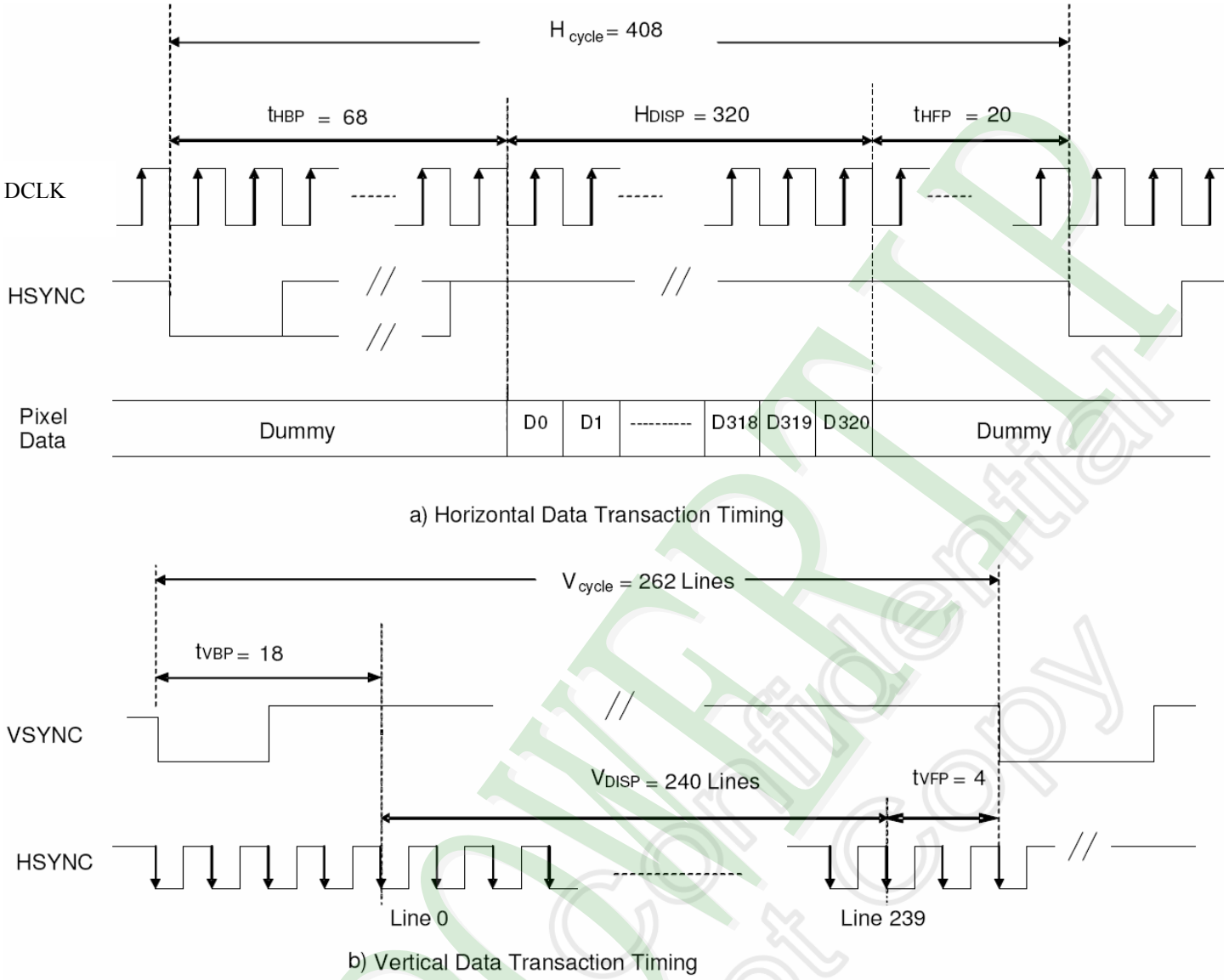


Pixel timing

Characteristics	Symbol	Min.		Typ.		Max.		Unit
		24-bit	8-bit	24- bit	8-bit	24-bit	8-bit	
DCLK Frequency	DCLK	-	-	6.5	19.5	10	30	MHz
DCLK Period	DCLK	100	33.3	154	51.3	-	-	ns
Vertical Sync Setup Time	tvsys	20	10	-	-	-	-	ns
Vertical Sync Hold Time	tvsyh	20	10	-	-	-	-	ns
Horizontal Sync Setup Time	thsys	20	10	-	-	-	-	ns
Horizontal Sync Hold Time	thsyh	20	10	-	-	-	-	ns
Phase difference of Sync Signal Falling Edge	thv	1		-		240		tDOTCLK
DCLK Low Period	tCKL	50	15	-	-	-	-	ns
DCLK High Period	tCKH	50	15	-	-	-	-	ns
Data Setup Time	tds	12	10	-	-	-	-	ns
Data hold Time	tdh	12	10	-	-	-	-	ns
Reset pulse width	tRES	10		-		-		μs

Note: External clock source must be provided to DCLK pin of HX8238-D.The driver will not operate if absent of the clocking signal.

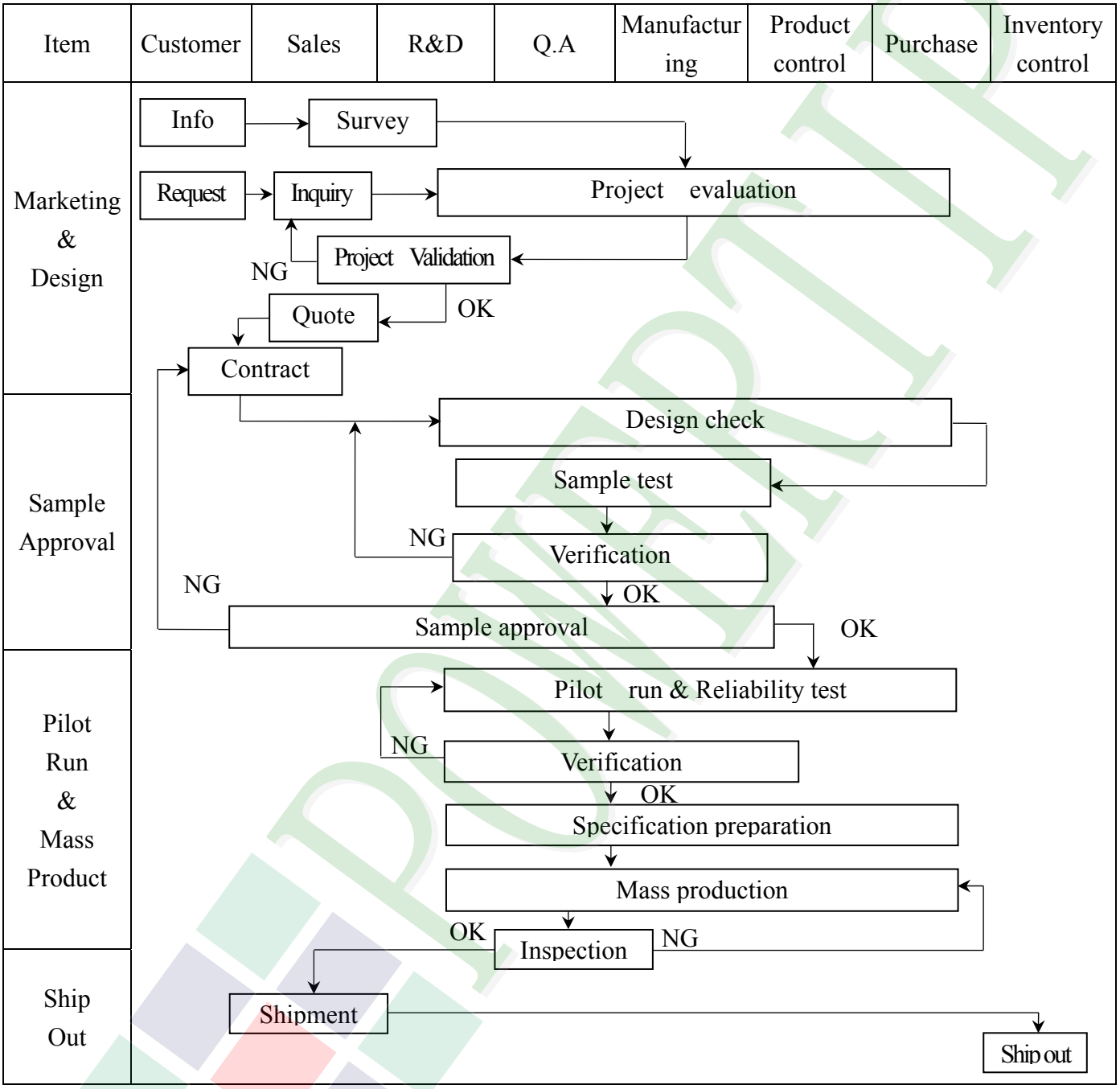
Note：The interface of this module can drive by digital 24-bit data.

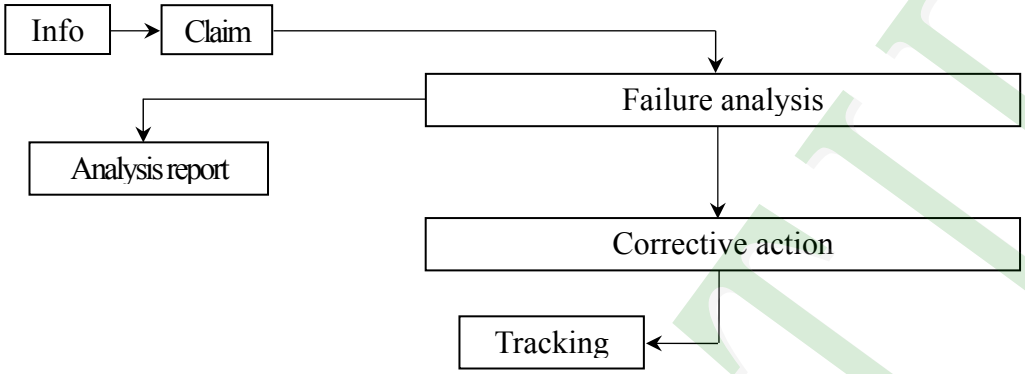


Data transaction timing in parallel RGB(24 bit)interface (SYNC mode)

3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart



Item	Customer	Sales	R&D	Q.A	Manufactu ring	Product control	Purchase	Inventory control
Sales Service								
Q.A Activity	1. ISO 9001 Maintenance Activities 2. Process improvement proposal 3. Equipment calibration 4. Education And Training Activities 5. Standardization Management							

3.2. Inspection Specification

◆Scope：The document shall be applied to TFT-LCD Module for 3.5″ ~15″ (Ver.B01).

◆Inspection Standard：MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.

◆Equipment：Gauge、MIL-STD、Powertip Tester、Sample

◆Defect Level：Major Defect AQL： 0.4 ； Minor Defect AQL： 1.5

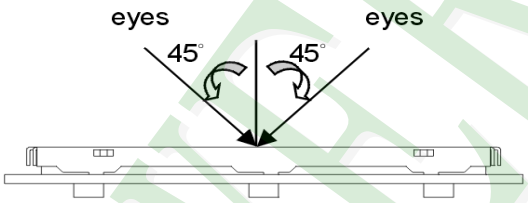
◆OUT Going Defect Level：Sampling.

◆Standard of the product appearance test：

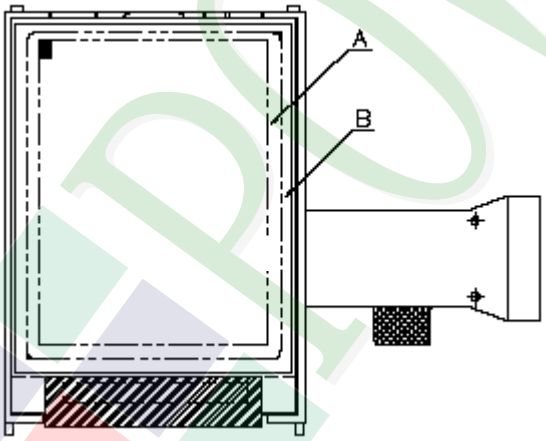
a. Manner of appearance test：

(1). The test best be under 20W×2 fluorescent light，and distance of view must be at 30 cm.

(2). The test direction is base on about around 45° of vertical line.



(3). Definition of area.



A area : viewing area

B area : Outside of viewing area

(4). Standard of inspection： (Unit：mm)

◆Specification For TFT-LCD Module 3.5″ ~15″：

(Ver.B01)

<table>
<tr><th>NO</th><th>Item</th><th>Criterion</th><th>Level</th></tr>
<tr><td rowspan="3">01</td><td rowspan="3">Product condition</td><td>1.1The part number is inconsistent with work order of production.</td><td>Major</td></tr>
<tr><td>1.2 Mixed product types.</td><td>Major</td></tr>
<tr><td>1.3 Assembled in inverse direction.</td><td>Major</td></tr>
<tr><td>02</td><td>Quantity</td><td>2.1The quantity is inconsistent with work order of production.</td><td>Major</td></tr>
<tr><td>03</td><td>Outline dimension</td><td>3.1 Product dimension and structure must conform to structure diagram.</td><td>Major</td></tr>
<tr><td rowspan="6">04</td><td rowspan="6">Electrical Testing</td><td>4.1 Missing line character and icon.</td><td>Major</td></tr>
<tr><td>4.2 No function or no display.</td><td>Major</td></tr>
<tr><td>4.3 Display malfunction.</td><td>Major</td></tr>
<tr><td>4.4 LCD viewing angle defect.</td><td>Major</td></tr>
<tr><td>4.5 Current consumption exceeds product specifications.</td><td>Major</td></tr>
<tr><td>4.6 Mura can not be seen through 5% ND filter.
(Mura : Under the normal examination angle of view,the picture has the non-uniform phenomenon.)</td><td>Minor</td></tr>
<tr><td>05</td><td>Dot defect

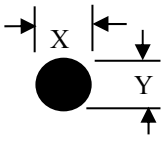
(Bright dot、Dark dot)

On -display</td><td>
<table>
<tr><th colspan="2">Item</th><th>Acceptance (Q’ty)</th></tr>
<tr><td rowspan="4">Dot Defect</td><td>Bright Dot</td><td>≦ 4</td></tr>
<tr><td>Dark Dot</td><td>≦ 5</td></tr>
<tr><td>Joint Dot</td><td>≦ 3</td></tr>
<tr><td>Total</td><td>≦ 7</td></tr>
</table>
5.1 Inspection pattern：full white , full black , Red , Green and blue screens.
5.2 It is defined as dot defect if defect area ＞1/2 dot.
5.3 The distance between two dot defect ≧5 mm.
5.4 Bright dot that can not be seen through 5% ND filter.
</td><td>Minor</td></tr>
</table>

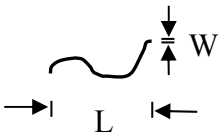
◆Specification For TFT-LCD Module 3.5″ ~15″：

(Ver.B01)

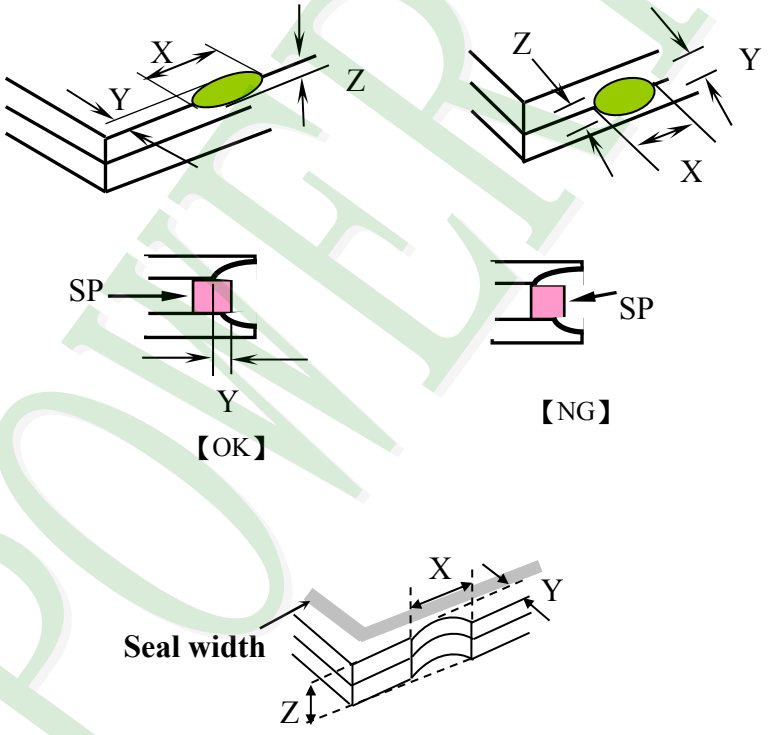
<table>
<tr><th>NO</th><th>Item</th><th>Criterion</th><th>Level</th></tr>
<tr><td>06</td><td>Black or white dot、scratch、contamination

Round type
 

Φ＝(x＋y) / 2

Line type
 
</td><td>6.1 Round type (Non-display or display)：
<table><tr><th rowspan="2">Dimension (diameter：Φ)</th><th colspan="2">Acceptance (Q’ty)</th></tr><tr><th>A area</th><th>B area</th></tr><tr><td>Φ ≦ 0.25</td><td>Ignore</td><td rowspan="4">Ignore</td></tr><tr><td>0.25 ＜ Φ ≦ 0.50</td><td>5</td></tr><tr><td>Φ ＞ 0.50</td><td>0</td></tr><tr><td>Total</td><td>5</td></tr></table>6.2 Line type(Non-display or display)：
<table><tr><th rowspan="2">module size</th><th>Length (L)</th><th rowspan="2">Width (W)</th><th colspan="2">Acceptance (Q’ty)</th></tr><tr><th>A area</th><th>B area</th></tr><tr><td rowspan="5">3.5” to less 9”</td><td>---</td><td>W ≦ 0.03</td><td>Ignore</td><td rowspan="5">Ignore</td></tr><tr><td>L ≦10.0</td><td>0.03 ＜W ≦ 0.05</td><td>4</td></tr><tr><td>L ≦5.0</td><td>0.05 ＜W ≦ 0.10</td><td>2</td></tr><tr><td>---</td><td>W ＞0.10</td><td>As round type</td></tr><tr><td colspan="2">Total</td><td>5</td></tr><tr><td rowspan="4">9” to 15”</td><td>---</td><td>W ≦ 0.05</td><td>Ignore</td><td rowspan="4">Ignore</td></tr><tr><td>L ≦10.0</td><td>0.05 ＜W ≦ 0.10</td><td>5</td></tr><tr><td>---</td><td>W ＞0.10</td><td>As round type</td></tr><tr><td colspan="2">Total</td><td>5</td></tr></table></td><td>Minor</td></tr>
<tr><td>07</td><td>Polarizer Bubble</td><td><table><tr><th rowspan="2">Dimension (diameter：Φ)</th><th colspan="2">Acceptance (Q’ty)</th></tr><tr><th>A area</th><th>B area</th></tr><tr><td>Φ ≦ 0.25</td><td>Ignore</td><td rowspan="5">Ignore</td></tr><tr><td>0.25 ＜ Φ ≦ 0.50</td><td>4</td></tr><tr><td>0.50 ＜ Φ ≦ 0.80</td><td>1</td></tr><tr><td>Φ ＞ 0.80</td><td>0</td></tr><tr><td>Total</td><td>5</td></tr></table></td><td>Minor</td></tr>
</table>

◆Specification For TFT-LCD Module 3.5″ ~15″ : (Ver.B01)

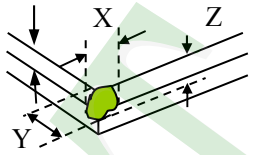
NO	Item	Criterion	Level
08	The crack of glass	Symbols : X : The length of crack Y : The width of crack. Z : The thickness of crack W : terminal length t : The thickness of glass a : LCD side length 8.1 General glass chip : 8.1.1 Chip on panel surface and crack between panels:  	Minor

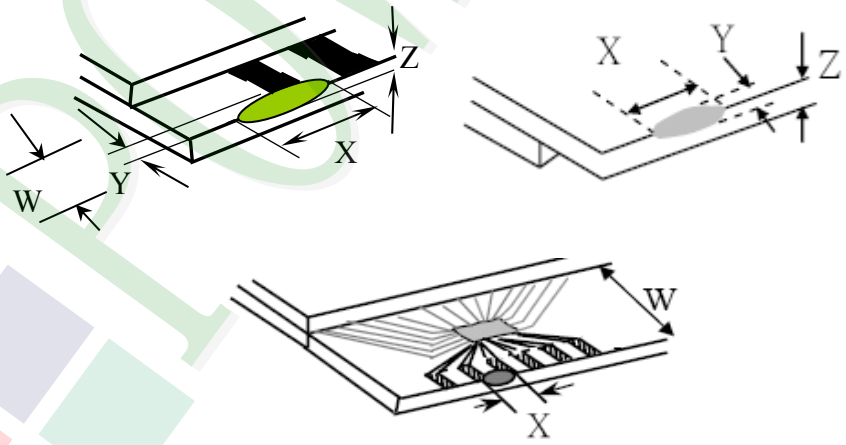
X	Y	Z
≦ a	Crack can't enter viewing area	≦1/2 t
≦ a	Crack can't exceed the half of SP width.	1/2 t < Z ≦2 t

◆Specification For TFT-LCD Module 3.5″ ~15″ : (Ver.B01)

<table>
<tr><th>NO</th><th>Item</th><th>Criterion</th><th>Level</th></tr>
<tr><td rowspan="2">08</td><td rowspan="2">The crack of glass</td><td>Symbols :

X : The length of crack
Z : The thickness of crack
t : The thickness of glass
Y : The width of crack.
W : terminal length
a : LCD side length

8.1.2 Corner crack :
 

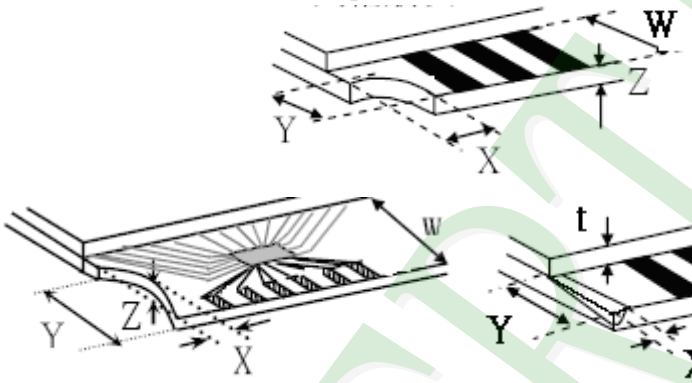
<table><tr><th>X</th><th>Y</th><th>Z</th></tr><tr><td>≦1/5 a</td><td>Crack can’t enter viewing area</td><td>Z ≦ 1/2 t</td></tr><tr><td>≦1/5 a</td><td>Crack can’t exceed the half of SP width.</td><td>1/2 t < Z ≦ 2 t</td></tr></table></td><td></td></tr>
<tr><td>8.2 Protrusion over terminal :
8.2.1 Chip on electrode pad :
 

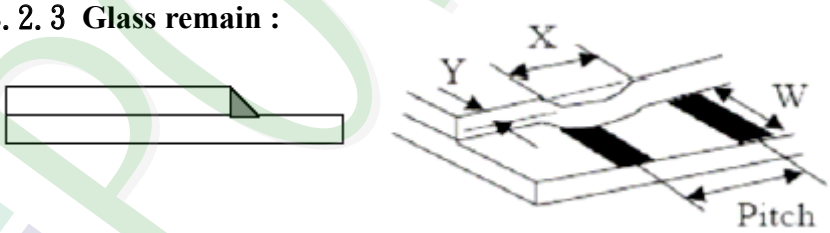
<table><tr><th></th><th>X</th><th>Y</th><th>Z</th></tr><tr><td>Front</td><td>≦ a</td><td>≦ 1/2 W</td><td>≦ t</td></tr><tr><td>Back</td><td>≦ a</td><td>≦ W</td><td>≦ 1/2 t</td></tr></table></td><td>Minor</td></tr>
</table>

◆Specification For TFT-LCD Module 3.5″ ~15″ : (Ver.B01)

<table>
<tr><th>NO</th><th>Item</th><th>Criterion</th><th>Level</th></tr>
<tr><td>08</td><td>The crack of glass</td><td>
Symbols :

X : The length of crack Y : The width of crack.
Z : The thickness of crack W : terminal length
t : The thickness of glass a : LCD side length

8.2.2 Non-conductive portion :


<table>
<tr><th>X</th><th>Y</th><th>Z</th></tr>
<tr><td>≦ 1/3 a</td><td>≦ W</td><td>≦t</td></tr>
</table>
⊙ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications.
8.2.3 Glass remain :


<table>
<tr><th>X</th><th>Y</th><th>Z</th></tr>
<tr><td>≦ a</td><td>≦ 1/3 W</td><td>≦t</td></tr>
</table>
8.2.4 Cracking

Not Allowed
</td><td>Minor</td></tr>
</table>

◆Specification For TFT-LCD Module 3.5″ ~15″ : (Ver.B01)

NO	Item	Criterion	Level
09	Backlight elements	9.1 Backlight can't work normally.	Major
		9.2 Backlight doesn't light or color is wrong.	Major
		9.3 Illumination source flickers when lit.	Major
10	General appearance	10.1 Pin type、quantity、dimension must match type in structure diagram.	Major
		10.2 No short circuits in components on PCB or FPC .	Major
		10.3 Parts on PCB or FPC must be the same as on the production characteristic chart .There should be no wrong parts , missing parts or excess parts.	Major
		10.4 Product packaging must the same as specified on packaging specification sheet.	Minor
		10.5 The folding and peeled off in polarizer are not acceptable.	Minor
		10.6 The PCB or FPC between B/L assembled distance(PCB or FPC) is ≦1.5 mm.	Minor

4. RELIABILITY TEST

4.1 Reliability Test Condition (Ver.B01)

<table>
<tr><th>NO.</th><th>TEST ITEM</th><th>TEST CONDITION</th></tr>
<tr><td>1</td><td>High Temperature Storage Test</td><td>Keep in +80 ±2℃ 240 hrs
Surrounding temperature, then storage at normal condition 4hrs.</td></tr>
<tr><td>2</td><td>Low Temperature Storage Test</td><td>Keep in -30 ±2℃ 240 hrs
Surrounding temperature, then storage at normal condition 4hrs.</td></tr>
<tr><td>3</td><td>High Temperature / High Humidity Storage Test</td><td>Keep in +60℃ / 90% R.H duration for 240 hrs
Surrounding temperature, then storage at normal condition 4hrs.
(Excluding the polarizer)</td></tr>
<tr><td>4</td><td>Temperature Cycling Storage Test</td><td>-30℃ → +25℃ → +80℃ → +25℃
(30mins) (5mins) (30mins) (5mins)
20 Cycle
Surrounding temperature, then storage at normal condition 4hrs.</td></tr>
<tr><td rowspan="2">5</td><td rowspan="2">ESD Test</td><td>Air Discharge:
Apply 2 KV with 5 times
Discharge for each polarity +/-
Contact Discharge:
Apply 250 V with 5 times
discharge for each polarity +/-</td></tr>
<tr><td>1. Temperature ambiance : 15℃～35℃
2. Humidity relative : 30%～60%
3. Energy Storage Capacitance(Cs+Cd) : 150pF±10%
4. Discharge Resistance(Rd) : 330Ω±10%
5. Discharge, mode of operation :
Single Discharge (time between successive discharges at least 1 sec)
(Tolerance if the output voltage indication : ±5%)</td></tr>
<tr><td>6</td><td>Vibration Test (Packaged)</td><td>1. Sine wave 10～55 Hz frequency (1 min/sweep)
2. The amplitude of vibration :1.5 mm
3. Each direction (X、Y、Z) duration for 2 Hrs</td></tr>
<tr><td>7</td><td>Drop Test (Packaged)</td><td><table><tr><th>Packing Weight (Kg)</th><th>Drop Height (cm)</th></tr><tr><td>0 ~ 45.4</td><td>122</td></tr><tr><td>45.4 ~ 90.8</td><td>76</td></tr><tr><td>90.8 ~ 454</td><td>61</td></tr><tr><td>Over 454</td><td>46</td></tr></table>Drop Direction :※1 corner / 3 edges / 6 sides each 1time</td></tr>
</table>

5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

5.1.1 If the LCD panel breaks , be careful not to get the liquid crystal to touch your skin.

5.1.2 If the liquid crystal touches your skin or clothes , please wash it off immediately by using soap and water.

5.2 HANDLING

5.2.1 Avoid any strong mechanical shock which can break the glass.

5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module , be sure to ground your body and any electrical equipment you may be using.

5.2.3 Do not remove the panel or frame from the module.

5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)

5.2.5 Do not wipe the polarizing plate with a dry cloth , as it may easily scratch the surface of plate.

5.2.6 Do not touch the display area with bare hands , this will stain the display area.

5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.

5.2.8 To control temperature and time of soldering is 320 ± 10°C and 3-5 sec.

5.2.9 To avoid liquid (include organic solvent) stained on LCM

5.2.10 Caution!(LCM products with Capacitive Touch Panel)

Strong EMI-sources such as switch-mode power supplies (SMPS) can lead to touch malfunction (e.g. ghost-touches).

Therefore, the touch needs to be thoroughly tested inside the target application.

5.3 STORAGE

5.3.1 Store the panel or module in a dark place where the temperature is 25°C ± 5°C and the humidity is below 65% RH.

5.3.2 Do not place the module near organics solvents or corrosive gases.

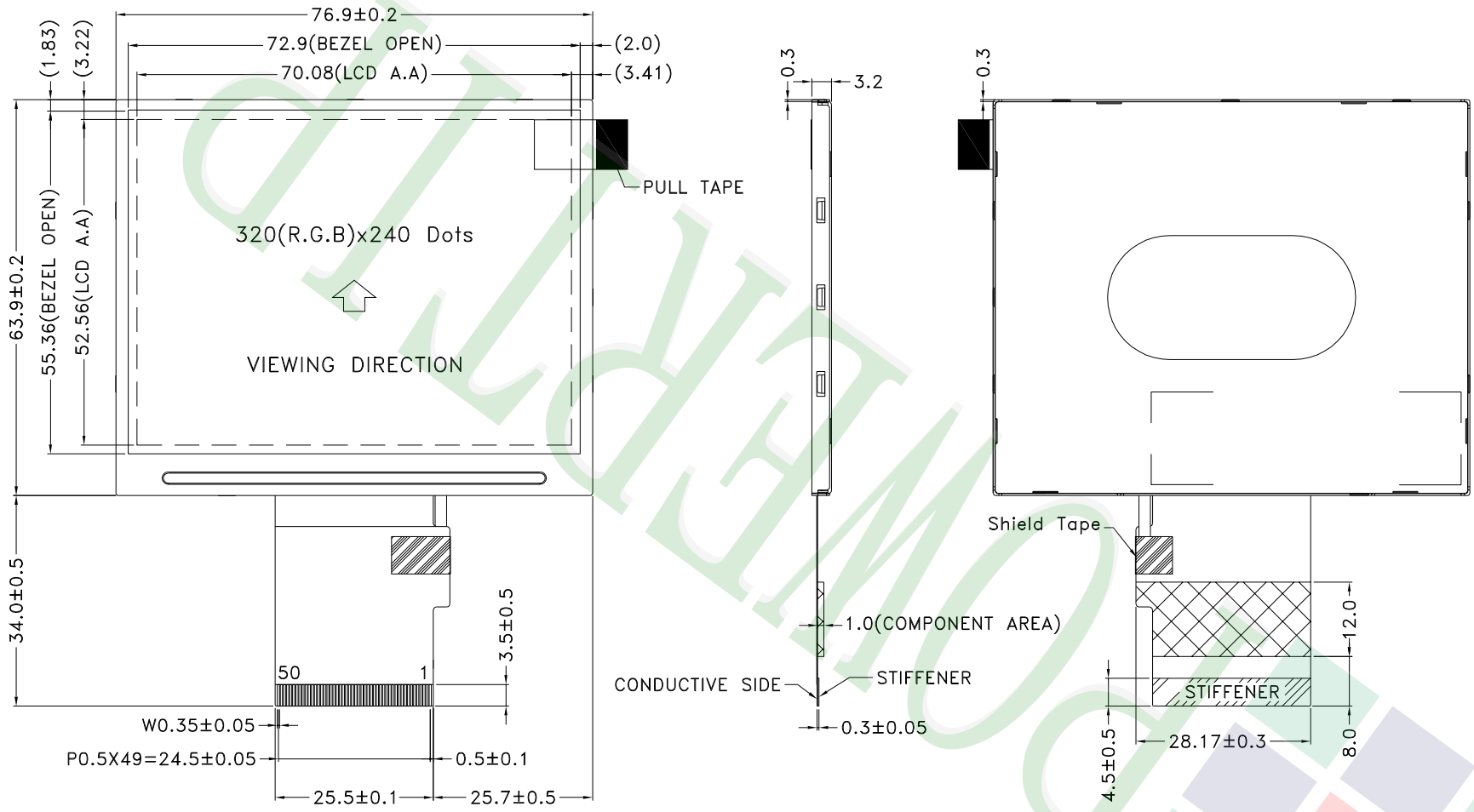
5.3.3 Do not crush , shake , or jolt the module.

5.4 TERMS OF WARRANTY

5.4.1 Applicable warrant period The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment , fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



NOTES:

1.LCD TYPE: a-SI TFT
2.LCD DISPLAY:POSITIVE/ TRANSMISSIVE
3.VIEW DIRECTION: 6 O'CLOCK
4.The tolerance unless classified ±0.3mm
5.FPC Matching Connector: Kyocera 08 6282 050 340 829+ or EQUIVALENT

REV	REV BY	REVISER	DATE
007			
006			
005			
004			
003			
002			
001	NEW DRAWING	Crystal	2018/03/19

PART NO: PH320240T023-IBA09

DRAWING NAME : JLMD-PH320240T023-IBA09

TITLE: LCD MODULE DRAWING

久正光電股份有限公司
POWERTIP TECHNOLOGY CORPORATION

Design	Crystal	(3)	Surface		
Check	Terry	Unit	MM	Material	
Scale	FIT			Thickness	
Approve	Ryan	Page	1/2	Quantity	

Precision / Length(Min) (mm)	Precision Level
1 ~ 4	-
4 ~ 16	-
16 ~ 63	-
63 ~ 250	-
250 ~ 1000	-

PT-A-054-0

Ver.001	
Documents NO.	JPKG-PH320240T023-IBA09

LCM包裝規格書
LCM Packaging Specifications
(For Tray)

Approve	Check	Contact
Ryan	Terry	Crystal

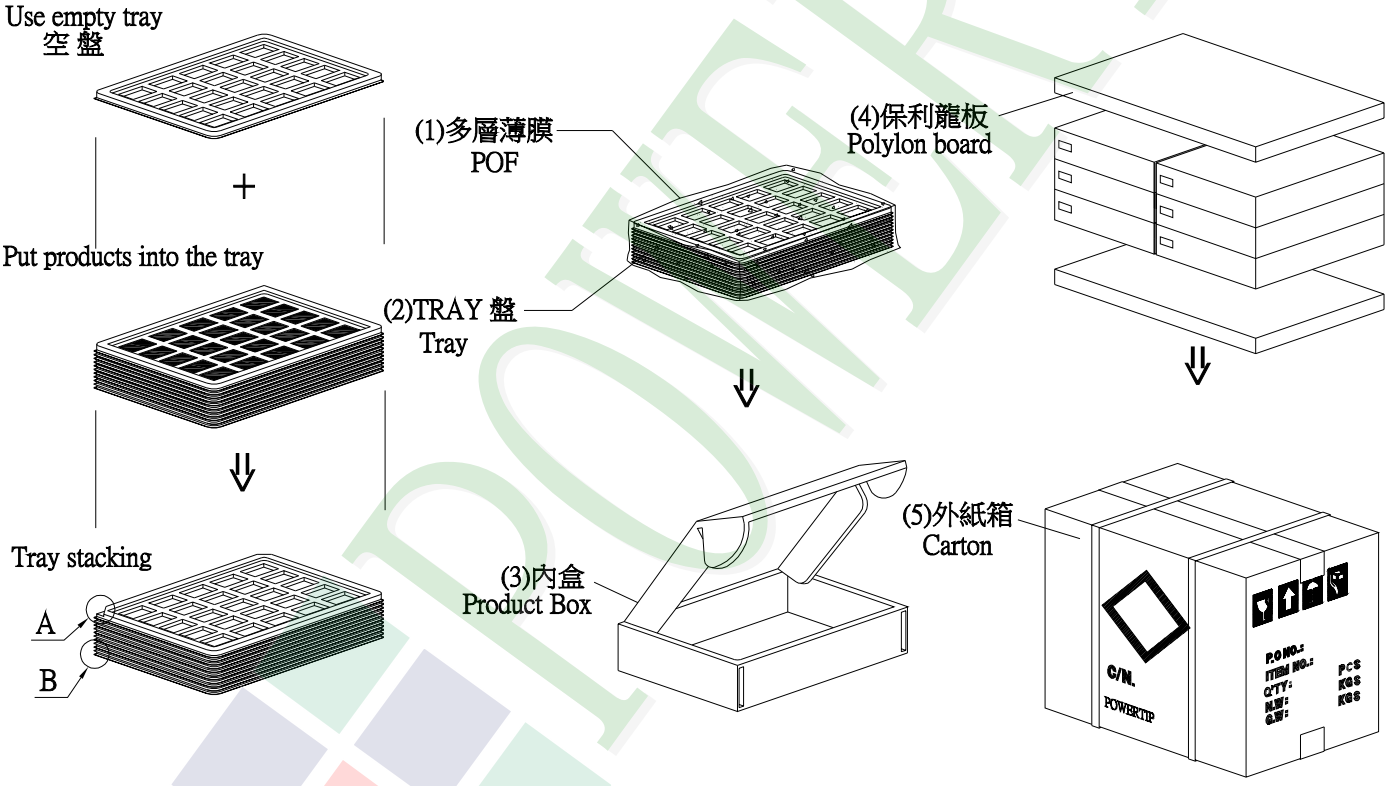
1.包裝材料規格表 (Packaging Material) : (per carton)

No.	Item	Model	Dimensions (mm)	1Pcs Weight	Quantity	Total Weight
1	成品 (LCM)	PH320240T023-IBA09	76.9 X 63.9 X 3.2	0.0324	288	9.3312
2	多層薄膜(1)POF	OTFILM0BA03ABA	19"X350X0.015	——	6	——
3	TRAY 盤 (2)Tray	TY32024001TZBA	352 X 260 X 10.8	0.1	54	5.4
4	內盒(3)Product Box	BX36627063ABBA	393 X 274 X 68	0.2692	6	1.6152
5	保利龍板(4)Polylon board	OTPLB00PL08ABA	550 X 393 X 20	0.0284	2	0.0568
6	外紙箱(5)Carton	BX57041027CCBA	570 X 410 X 265	1.4208	1	1.4208
7						
8						
9						

2.一 整箱總重量 (Total LCD Weight in carton) : 17.82 Kg±10%

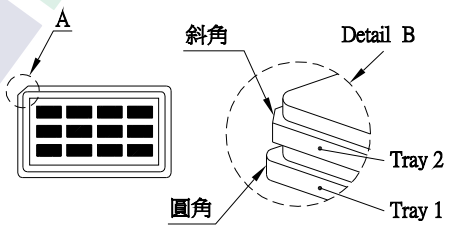
3.單箱數量規格表 (Packaging Specifications and Quantity) :

(1)LCM quantity per box : no per tray	6	x no of tray	8	=	48
(2)Total LCM quantity in carton : quantity per box	48	x no of boxes	6	=	288



特 記 事 項 (REMARK)

4. 參照"成品包裝點檢作業標準書"內容



5.TRAY盤相疊時,需旋轉180度,請詳見B視圖
Rotate tray 180 degrees and place on top of stack.
Check the tray stack using Fig. B.